



MDP15N60G / MDF15N60G

N-Channel MOSFET 600V, 15A, 0.40Ω

MDP15N60G / MDF15N60G N-Channel MOSFET 600V

General Description

These N-channel MOSFET are produced using advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

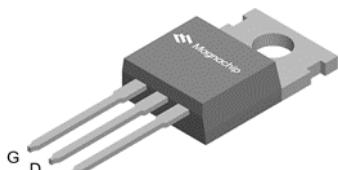
These devices are suitable device for SMPS, high Speed switching and general purpose applications.

Features

- $V_{DS} = 600V$
- $I_D = 15A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 0.40\Omega$ @ $V_{GS} = 10V$

Applications

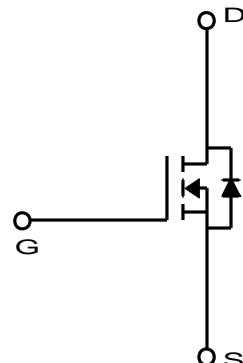
- Power Supply
- PFC
- High Current, High Speed Switching



TO-220
MDP Series



TO-220F
MDF Series



Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	MDP15N60G	MDF15N60G	Unit
Drain-Source Voltage		V_{DSS}	600		V
Gate-Source Voltage		V_{GSS}	± 30		V
Continuous Drain Current	$T_c=25^\circ C$	I_D	15	15*	A
	$T_c=100^\circ C$		9.5	9.5*	A
Pulsed Drain Current ⁽²⁾		I_{DM}	60	60*	A
Power Dissipation	$T_c=25^\circ C$	P_D	231.4	36.7	W
	Derate above 25 °C		1.85	0.29	W/°C
Repetitive Avalanche Energy ⁽²⁾		E_{AR}	23.1		mJ
Peak Diode Recovery dv/dt ⁽³⁾		dv/dt	4.5		V/ns
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	511		mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150		°C

* I_d limited by maximum junction temperature

Thermal Characteristics

Characteristics	Symbol	MDP15N60G	MDF15N60G	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{θJA}$	62.5	62.5	°C/W
Thermal Resistance, Junction-to-Case ⁽¹⁾	$R_{θJC}$	0.54	3.4	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDP15N60GTH	-55~150°C	TO-220	Tube	Halogen Free
MDF15N60GTH	-55~150°C	TO-220F	Tube	Halogen Free

Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	3.0	-	5.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V	-	-	100	nA
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 7.5A	-	0.34	0.40	Ω
Forward Transconductance	g _f	V _{DS} = 30V, I _D = 7.5A ⁽²⁾	-	11.5	-	S
Dynamic Characteristics						
Total Gate Charge	Q _g	V _{DS} = 480V, I _D = 15.0A, V _{GS} = 10V ⁽²⁾	-	49.0	-	nC
Gate-Source Charge	Q _{gs}		-	15.0	-	
Gate-Drain Charge	Q _{gd}		-	19.1	-	
Input Capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	-	2311	-	pF
Reverse Transfer Capacitance	C _{rss}		-	10.8	-	
Output Capacitance	C _{oss}		-	258	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 300V, I _D = 15.0A, R _G = 25Ω ⁽²⁾	-	57	-	ns
Rise Time	t _r		-	86	-	
Turn-Off Delay Time	t _{d(off)}		-	137	-	
Fall Time	t _f		-	47	-	
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I _S	I _S = 15.0A, V _{GS} = 0V	-	15	-	A
Source-Drain Diode Forward Voltage	V _{SD}		-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}		-	382	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	4.47	-	μC

Note :

1. Pulse width is based on R_{θJC} & R_{θJA} and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width ≤300us, duty cycle≤2%, pulse width limited by junction temperature T_{J(MAX)}=150°C.
3. I_{SD} ≤15A, di/dt≤200A/us, V_{DD}≤BVdss, R_g =25Ω, Starting T_J=25°C
4. L=7.9mH, I_{AS}=15.0A, V_{DD}=50V, R_g =25Ω, Starting T_J=25°C,

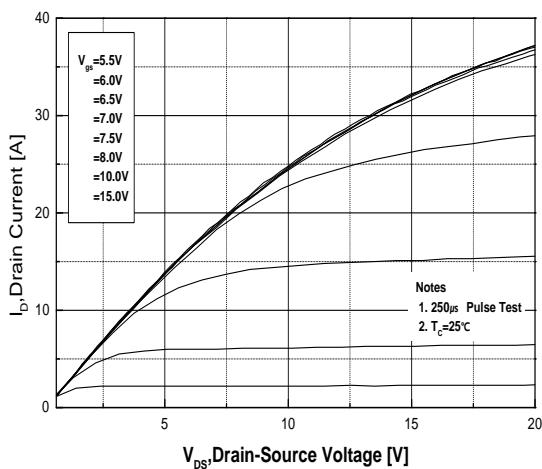


Fig.1 On-Region Characteristics

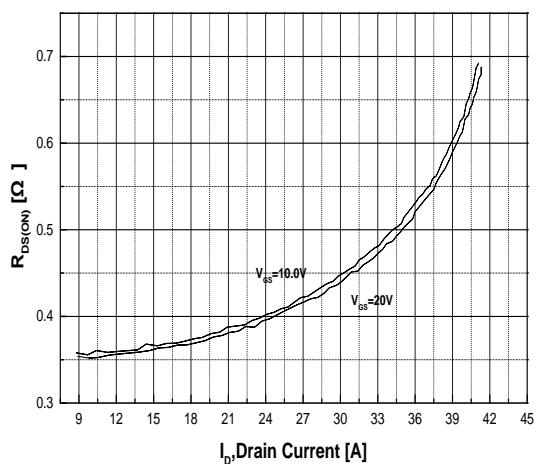


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

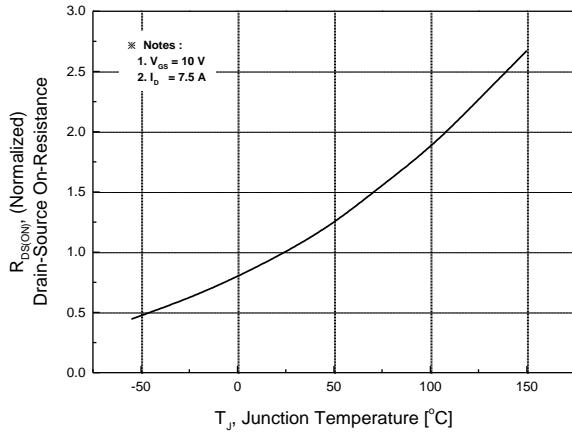


Fig.3 On-Resistance Variation with Temperature

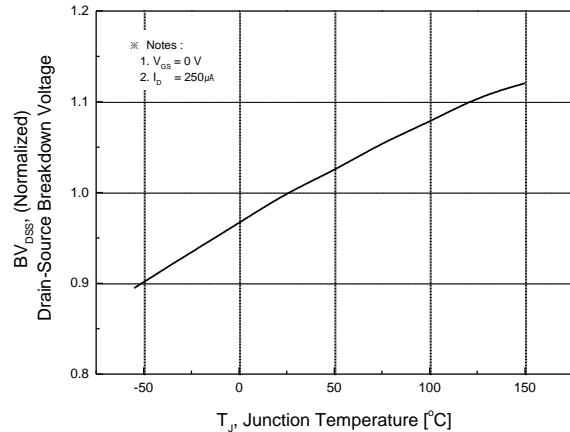


Fig.4 Breakdown Voltage Variation vs. Temperature

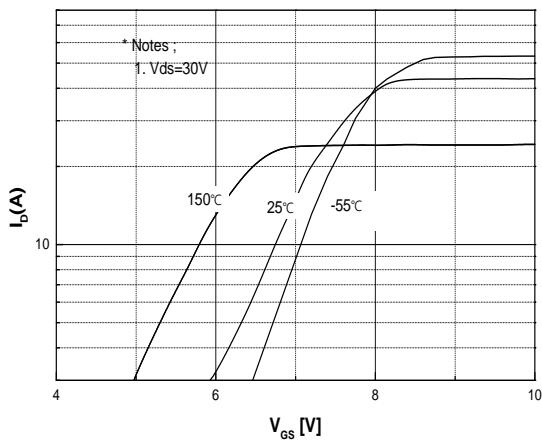


Fig.5 Transfer Characteristics

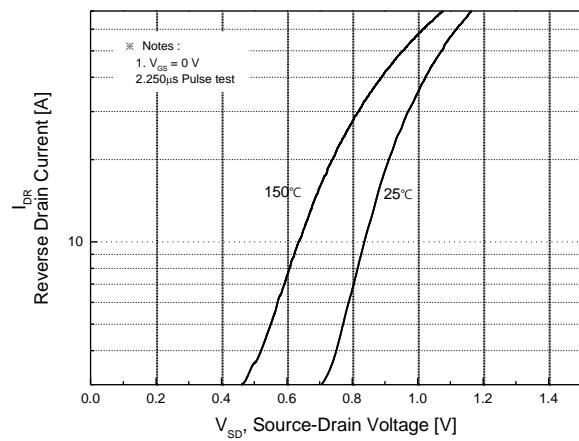


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

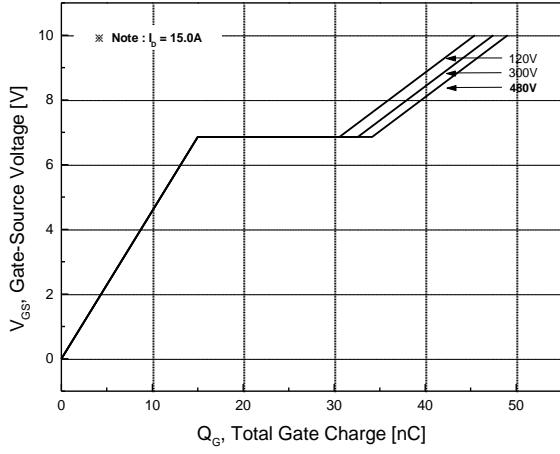


Fig.7 Gate Charge Characteristics

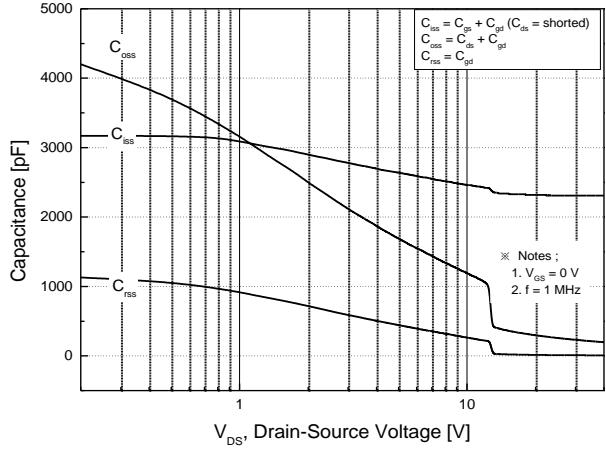
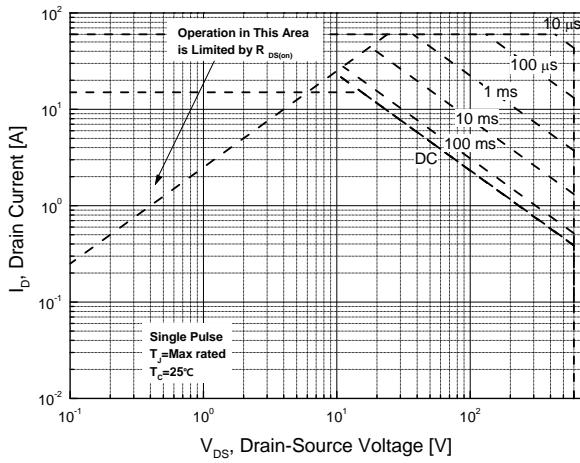
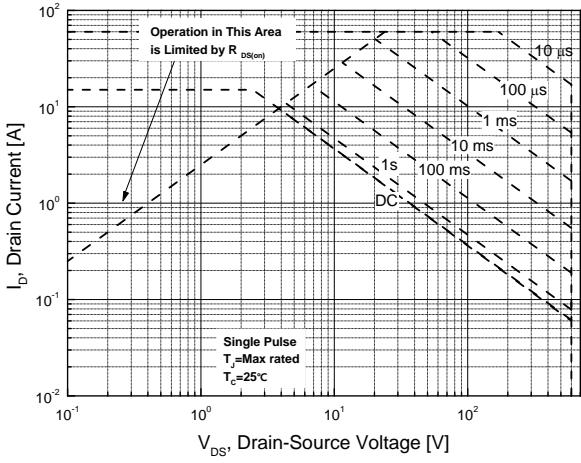


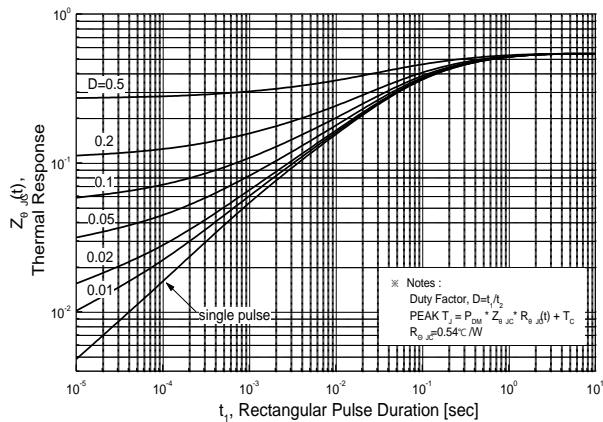
Fig.8 Capacitance Characteristics



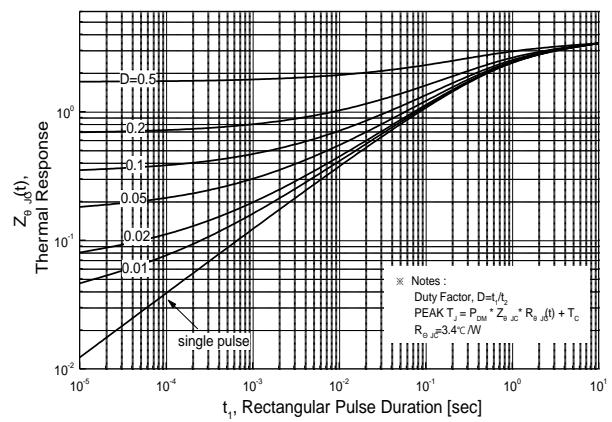
**Fig.9 Maximum Safe Operating Area
MDP15N60G(TO-220)**



**Fig.10 Maximum Safe Operating Area
MDF15N60G(TO-220F)**



**Fig.11 Transient Thermal Response Curve
MDP15N60G(TO-220)**



**Fig.12 Transient Thermal Response Curve
MDF15N60G(TO-220F)**

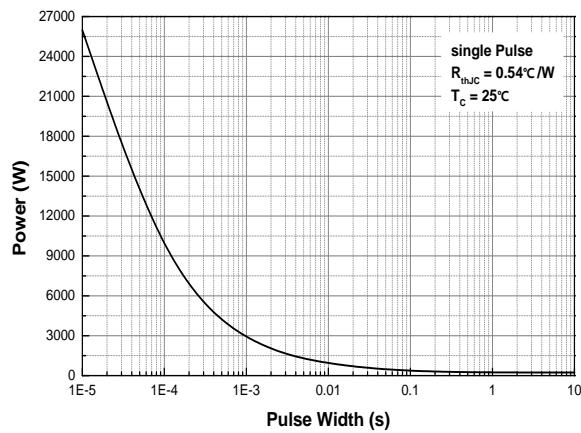


Fig.13 Single Pulse Maximum Power Dissipation MDP15N60G(TO-220)

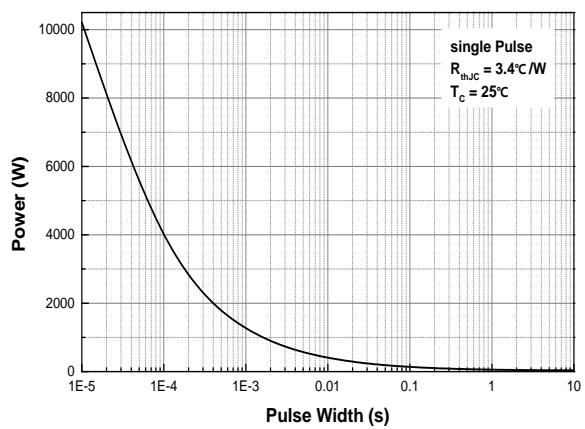


Fig.14 Single Pulse Maximum Power Dissipation MDF15N60G(TO-220F)

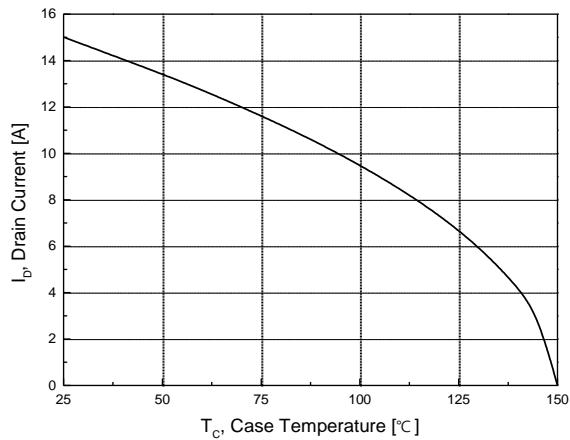
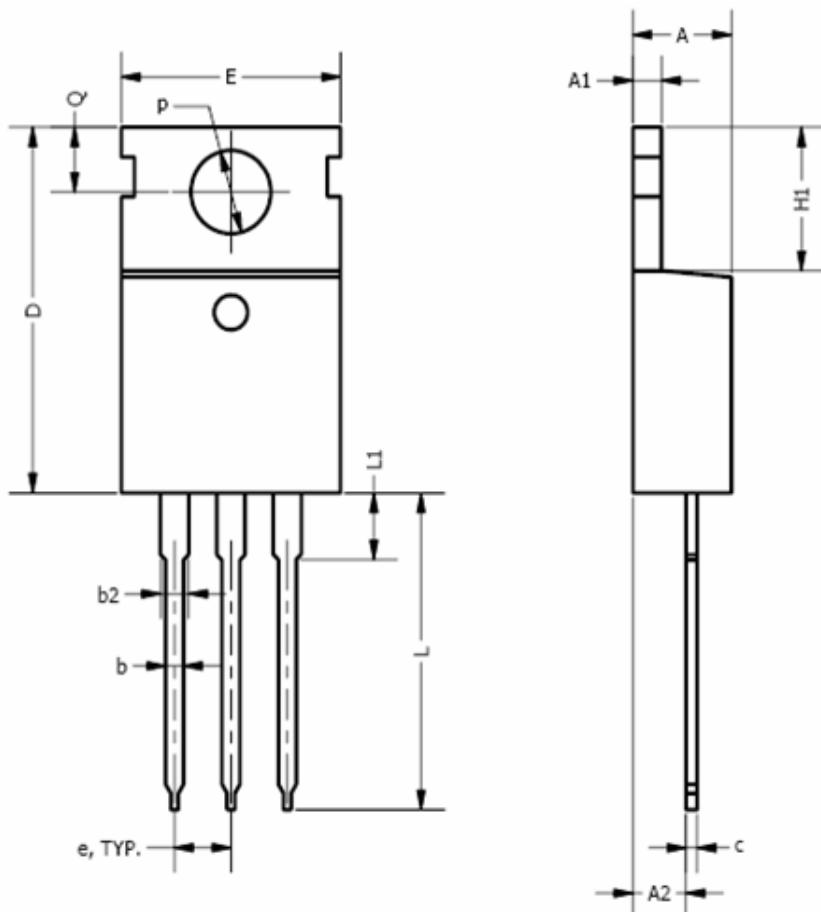


Fig.15 Maximum Drain Current vs. Case Temperature

Physical Dimensions

3 Leads, TO-220

Dimensions are in millimeters unless otherwise specified



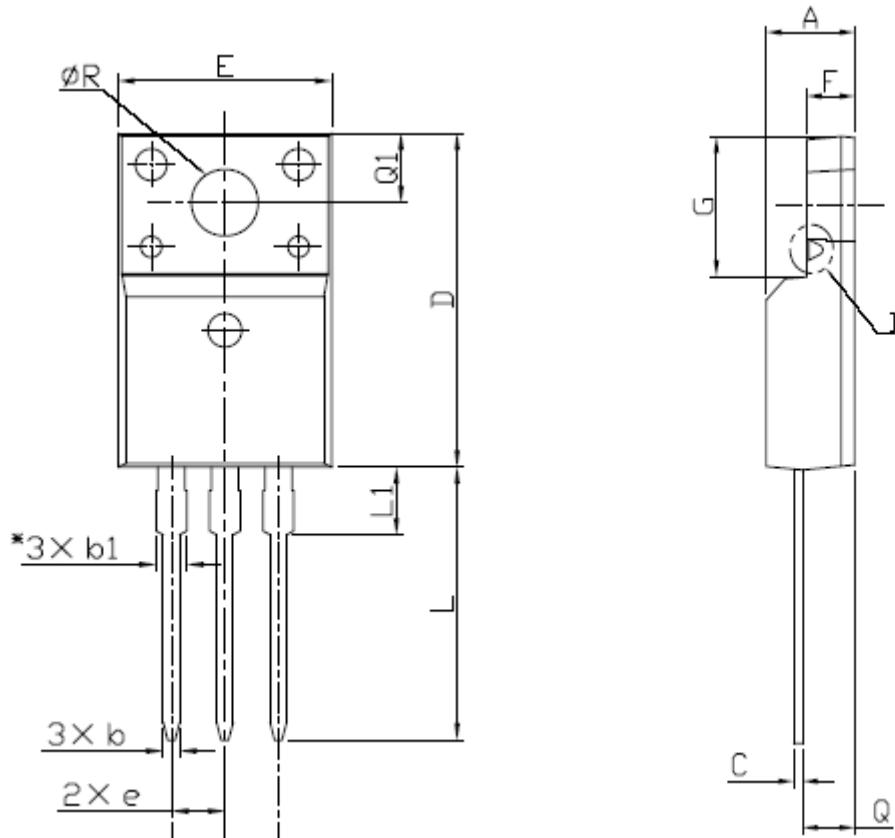
Symbol	Min	Nom	Max
A	3.56		4.83
A ₁	0.50		1.40
A ₂	2.03		2.92
b	0.38	0.69	1.02
b ₂	1.14	1.45	1.78
c	0.36		0.61
D	14.22		16.51
e	2.54 TYP		
E	9.65		10.67
H ₁	5.84		6.86
L	12.70		14.73
L ₁			6.35
φP	3.53		4.09
Q	2.54		3.43

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

Physical Dimensions

3 Leads, TO-220F

Dimensions are in millimeters unless otherwise specified



Symbol	Min	Nom	Max
A	4.50		4.93
b	0.63		0.91
b1	1.15		1.47
C	0.33		0.63
D	15.47		16.13
E	9.60		10.71
e		2.54	
F	2.34		2.84
G	6.48		6.90
L	12.24		13.72
L1	2.79		3.67
Q	2.52		2.96
Q1	3.10		3.50
ϕR	3.00		3.55

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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